

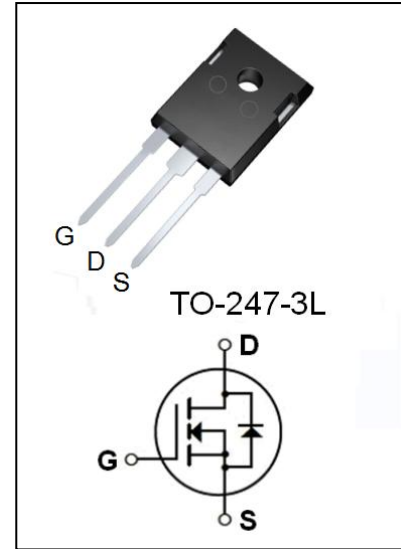


HCN65R099F-E

650V N-Channel Super Junction Power MOSFET

● Features:

- 35A, 650V, $R_{DS(on)(Typ)} = 90m\Omega @ V_{GS}=10V$
- Low Gate Charge
- Low C_{rSS}
- 100% Avalanche Tested
- Fast Switching
- Improved dv/dt Capability
- Application:
 - High Frequency Switching Mode Power Supply
 - Active Power Factor Correction



Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	650	V
I_D	Drain Current - Continuous ($T_c=25^\circ C$) - Continuous ($T_c=100^\circ C$)	35.0*	A
		22.1*	A
I_{DM}	Drain Current - Pulsed (Note1)	105*	A
V_{GSS}	Gate-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy (Limit Reference Value) (Note2)	495	mJ
I_{AR}	Avalanche Current (Note1)	6.0	A
dv/dt	Peak Diode Recovery dv/dt (Note3)	8.5	V/ns
P_D	Power Dissipation ($T_c = 25^\circ C$) - Derate above $25^\circ C$	269	W
		2.15	W/ $^\circ C$
T_j	Operating Junction Temperature	150	$^\circ C$
T_{stg}	Storage Temperature Range	-55 to +150	$^\circ C$

* Drain Current Limited by Maximum Junction Temperature.

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.465	$^\circ C / W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	60	$^\circ C / W$



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Electrical Characteristics(Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-source Breakdown Voltage	V _{GS} =0V, I _D =1mA	650	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =650V, V _{GS} =0V	--	--	15	μA
		V _{DS} =520V, Tc=125°C	--	400	--	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} =+20V, V _{DS} =0V	--	--	200	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} =-20V, V _{DS} =0V	--	--	-200	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250μA	3.0	--	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10 V, I _D =17.5A	--	90	103	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =100V, V _{GS} =0V, f=1.0MHz	--	1900	--	pF
C _{oss}	Output Capacitance		--	117	--	pF
C _{rss}	Reverse Transfer Capacitance		--	2.2	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 325 V, I _D =17.5 A, R _G = 27 Ω (Note4,5)	--	51	--	ns
t _r	Turn-On Rise Time		--	103	--	ns
t _{d(off)}	Turn-Off Delay Time		--	185	--	ns
t _f	Turn-Off Fall Time		--	52	--	ns
Q _g	Total Gate Charge	V _{DS} = 520 V, I _D =17.5 A, V _{GS} = 10 V (Note4,5)	--	71	--	nC
Q _{gs}	Gate-Source Charge		--	17	--	nC
Q _{gd}	Gate-Drain Charge		--	46	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	35	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	105	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} =0V, I _S =17.5A	--	--	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _S =17.5A, d I _F /dt=100A/μs (Note4)	--	145	--	ns
Q _{rr}	Reverse Recovery Charge		--	0.92	--	μC

Notes:

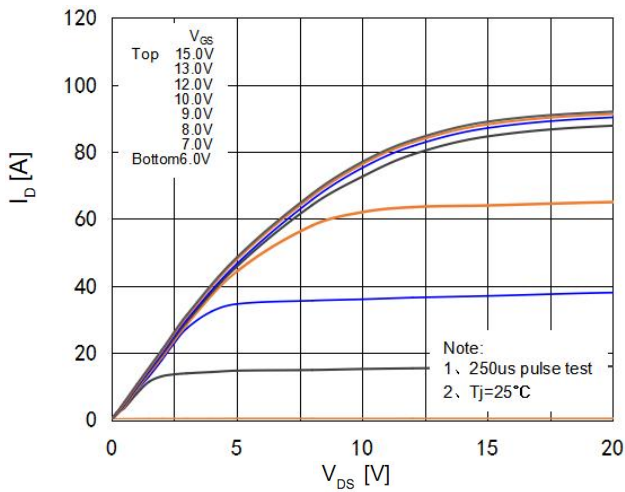
- 1、Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.
- 2、L = 25mH, I_{AS} =6.0A, V_{DD} = 100V, R_G = 25 Ω, Starting T_J = 25°C.
- 3、I_{SD}≤35.0A, di/dt≤200A/μs, V_{DD}≤BV_{DSS}, Starting T_J = 25°C.
- 4、Pulse Test : Pulse Width ≤300 μ s, Duty Cycle≤2%.
- 5、Essentially Independent of Operating Temperature.



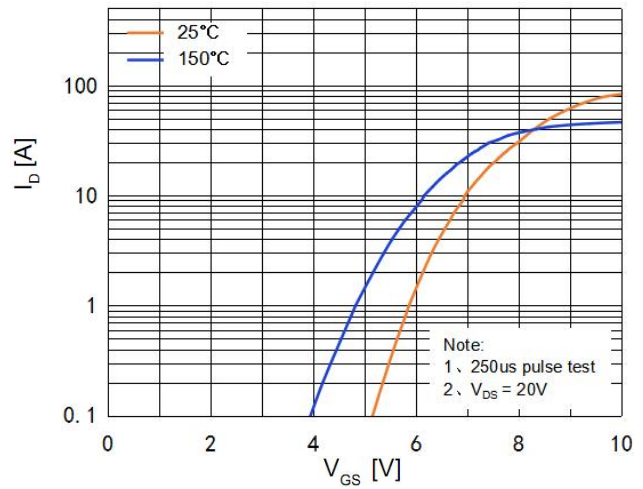
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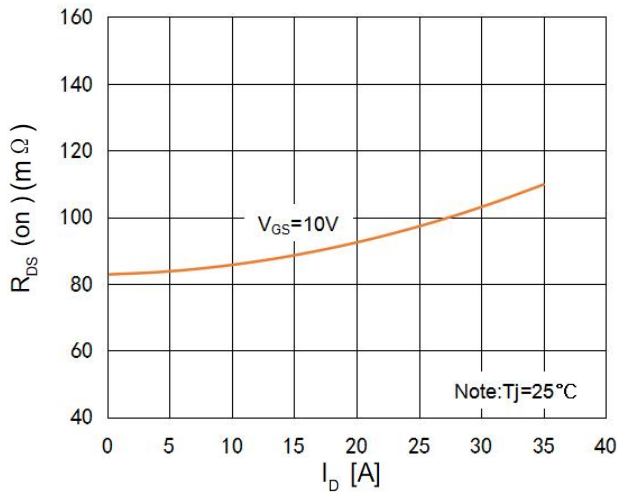
On-Regin Characteristics



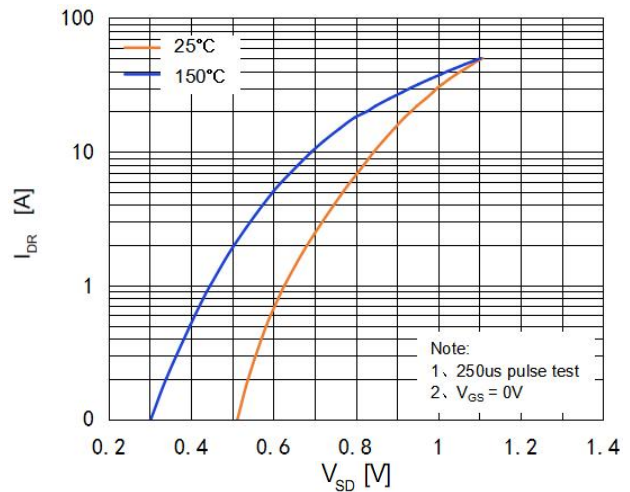
Transfer Characteristics



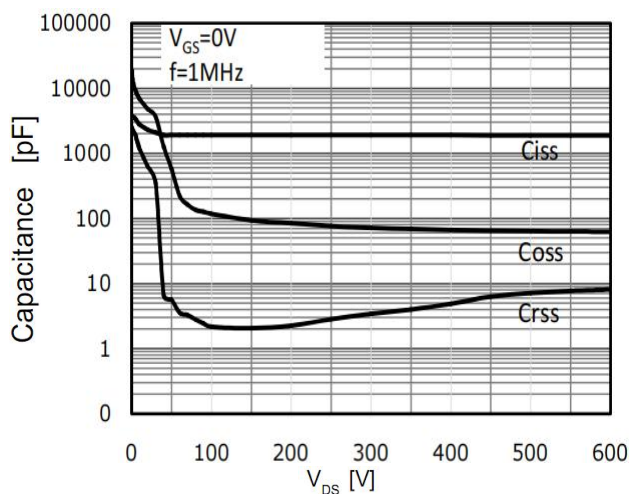
On-Resistance Variation vs. Drain Current and Gate Voltage



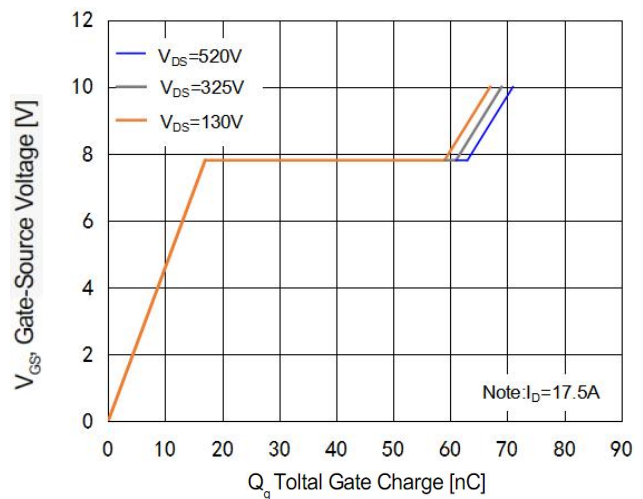
Body Diode Forward Voltage Variation vs. Source Current and Temperature



Capacitance Characteristics



Gate Charge Characteristics

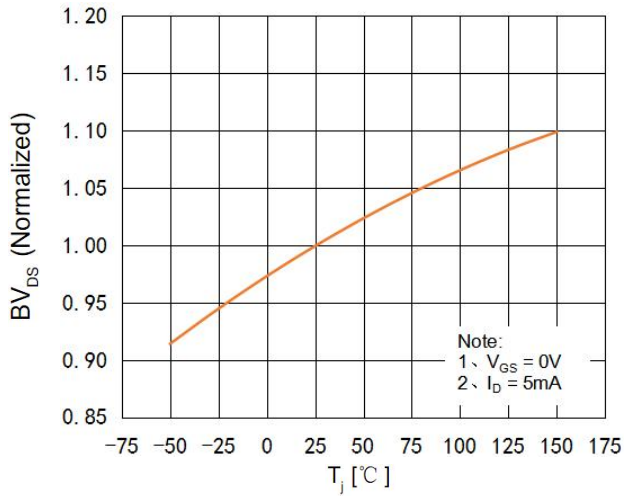




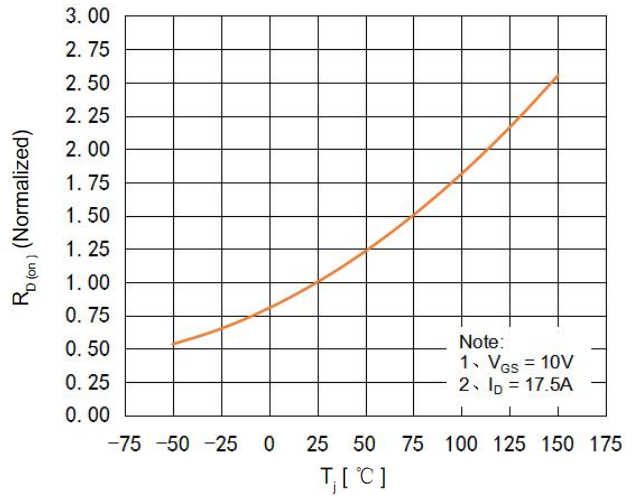
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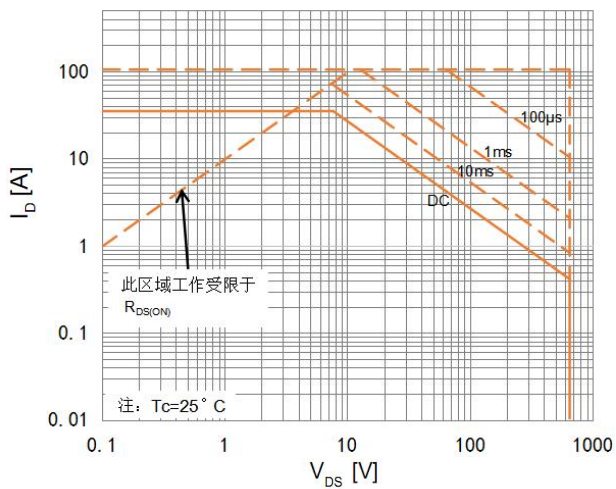
Breakdown Voltage Variation vs. Temperature



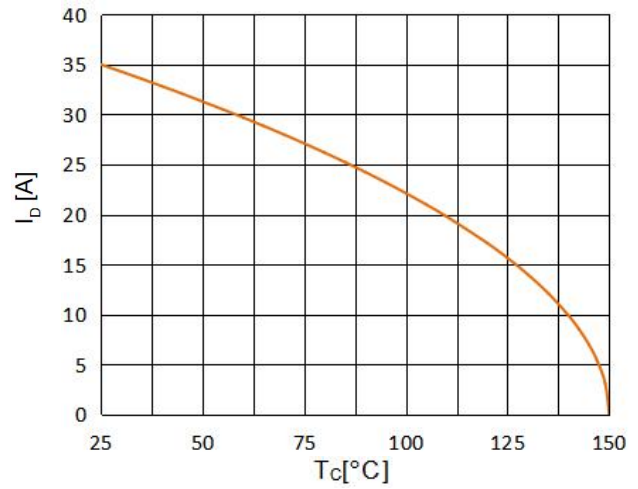
On-Resistance Variation vs. Temperature



Maximum Safe Operating Area



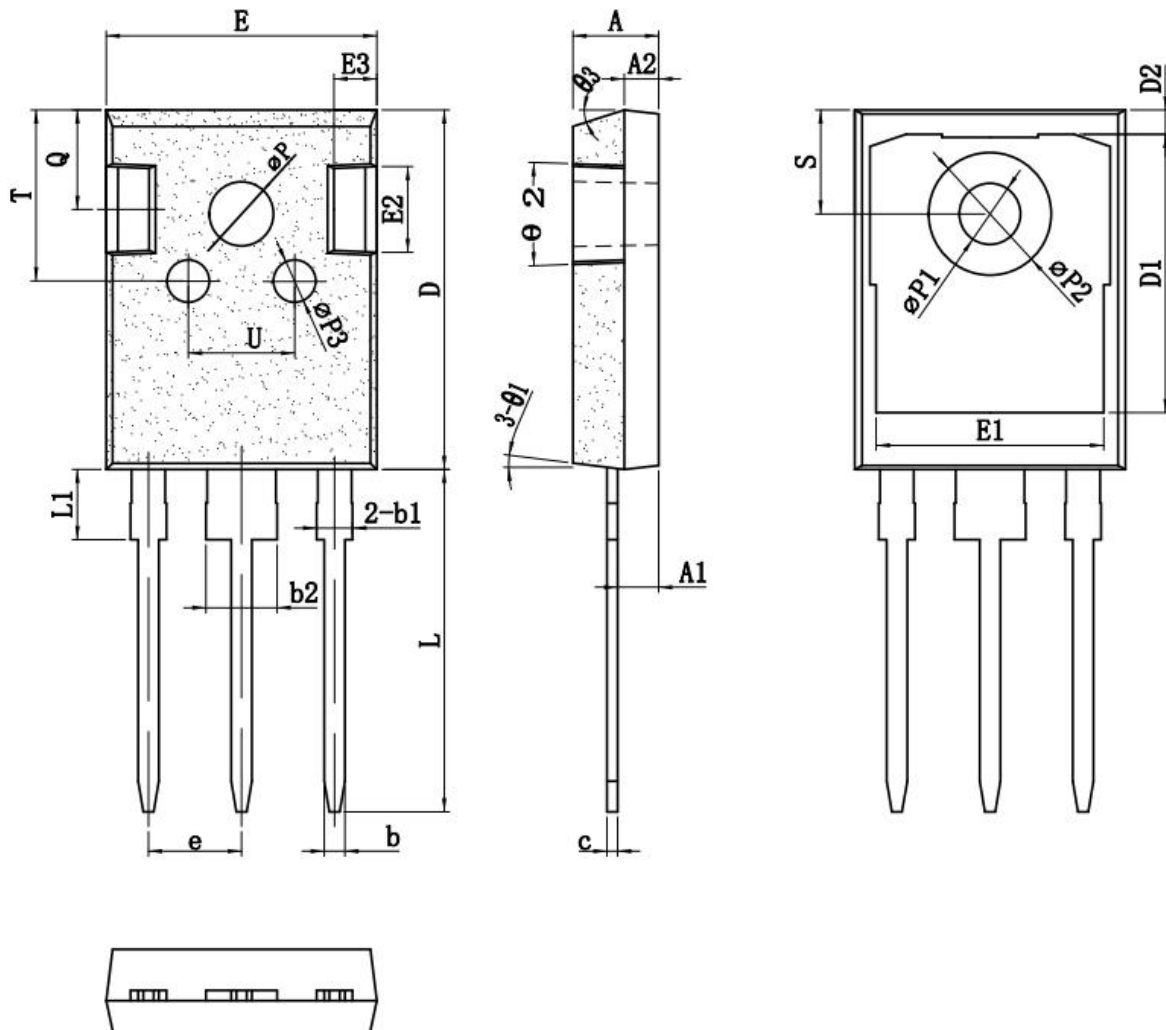
Maximum Drain Current Vs. Case Temperature



TO-247-3L Package Dimensions

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.70	5.00	5.30	e	--	5.44	--
A1	2.20	2.40	2.60	L	19.00	20.00	21.00
A2	1.80	2.00	2.20	L1	3.90	4.30	4.70
b	1.00	1.20	1.40	ΦP	3.40	3.60	3.80
b1	1.90	2.10	2.30	$\Phi P1$	3.30	3.50	3.70
b2	2.90	3.10	3.30	$\Phi P2$	6.88	7.18	7.48
c	0.50	0.60	0.70	$\Phi P3$	2.20	2.50	2.80
D	20.50	21.00	21.50	Q	5.30	5.80	6.30
D1	15.50	16.50	17.50	S	5.65	6.15	6.65
D2	0.90	1.20	1.50	T	9.00	10.00	11.00
E	15.30	15.80	16.30	U	5.20	6.20	7.20
E1	12.75	13.25	13.75	$\theta 1$	5°	7°	9°
E2	4.70	5.00	5.30	$\theta 2$	1°	3°	5°
E3	2.20	2.50	2.80	$\theta 3$	13°	15°	17°





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注意事项:

- 1、在电路设计时请不要超过器件的最大额定值，否则会影响整机的可靠性。
- 2、MOSFET产品为静电敏感型器件，使用时应注意采取防静电保护措施，如佩戴防静电手环、设备接地等。
- 3、如需安装散热片，请注意控制扭力大小及散热片的平整度。
- 4、该规格书由华科公司制作，并可能不定期更改，恕不另行通知。
- 5、如有疑问，请及时联系我司销售代表。

版本履历表:

序号	版本号	修改时间	修改记录
1	V1.0	2023-9-20	首次发行